

MOSFET

OptiMOS[™] 7 Power-Transistor, 15 V

Features

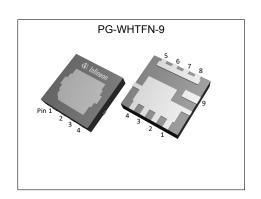
- N-channel, logic level
- Very low on-resistance R_{DS(on)}
 Superior thermal resistance
- 100% avalanche tested
- Pb-free lead plating; RoHS compliantHalogen-free according to IEC61249-2-21
- Optimized for high performance SMPS, e.g. synchronous rectification

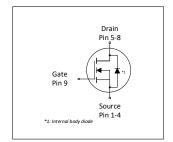
Product validation

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

Table 1 Roy Fortermance Farametere							
Parameter	Value	Unit					
$V_{ extsf{DS}}$	15	V					
$R_{ extsf{DS(on),max}}$	0.45	mΩ					
I _D	379	Α					
Qoss	27	nC					
Q _G	29	nC					











Type / Ordering Code	Package	Marking	Related Links
IQE004NE1LM7CGSC	PG-WHTFN-9	Н	-

OptiMOS[™] 7 Power-Transistor, 15 V



Rev. 2.0, 2023-07-25

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OptiMOS[™] 7 Power-Transistor, 15 V IQE004NE1LM7CGSC



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Damamatan	Symbol	Values				
Parameter		Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	- - -	-	379 240 58	A	V _{GS} =7 V, T _C =25 °C V _{GS} =7 V, T _C =100 °C V _{GS} =7 V, T _A =25 °C, R _{thJA} =60 °C/W ²)
Pulsed drain current ³⁾	I _{D,pulse}	-	-	1516	Α	<i>T</i> _A =25 °C
Avalanche energy, single pulse ⁴⁾	E _{AS}	-	-	859	mJ	I_D =20 A, R_{GS} =25 Ω
Recommended gate source voltage	V _{GS}	-7	-	7	V	-
Gate source voltage, transient	V _{GS,AC}	-8	-	8	V	t _{pulse} <20 ns
Power dissipation	P _{tot}	-	-	89 2.1	W	T _C =25 °C T _A =25 °C, R _{thJA} =60 °C/W ²⁾
Operating and storage temperature	T _j , T _{stg}	-55	-	150	°C	-

2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Offic	Note / Test Condition
Thermal resistance, junction - case, bottom	R _{thJC}	-	-	1.4	°C/W	-
Thermal resistance, junction - case, top	R _{thJC}	-	0.7	-	°C/W	-
Thermal resistance, junction - ambient, 6 cm² cooling area ⁵⁾	R _{thJA}	_	-	60	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual

environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for source connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information

⁵⁾ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for connection. PCB is vertical in still air.

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3 Electrical characteristics

at T_j=25 °C, unless otherwise specified

Table 4 Static characteristics

Parameter	0		Values			
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	15	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	$V_{\rm GS(th)}$	1.2	1.6	2.0	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 432 \mu {\rm A}$
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μA	V _{DS} =12 V, V _{GS} =0 V, T _j =25 °C V _{DS} =12 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I_{GSS}	-	10	100	nA	V _{GS} =7 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	0.37 0.47	0.45 0.57	mΩ	V _{GS} =7 V, I _D =30 A V _{GS} =4.5 V, I _D =20 A
Gate resistance	R _G	-	0.4	-	Ω	-
Transconductance	g fs	85	170	-	S	V _{DS} ≥2 I _D R _{DS(on)max} , I _D =30 A

Table 5 Dynamic characteristics

Devementar	Comphal	Values			11:4	Note / Took Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance	Ciss	-	4800	6240	pF	V _{GS} =0 V, V _{DS} =7.5 V, f=1 MHz
Output capacitance ¹⁾	Coss	-	2600	3380	pF	V _{GS} =0 V, V _{DS} =7.5 V, f=1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	260	455	pF	V _{GS} =0 V, V _{DS} =7.5 V, f=1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	9	-	ns	$V_{\rm DD}$ =7.5 V, $V_{\rm GS}$ =7 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	2	-	ns	$V_{\rm DD}$ =7.5 V, $V_{\rm GS}$ =7 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{ m d(off)}$	-	21	-	ns	$V_{\rm DD}$ =7.5 V, $V_{\rm GS}$ =7 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	4	-	ns	$V_{\rm DD}$ =7.5 V, $V_{\rm GS}$ =7 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 Ω

Table 6 Gate charge characteristics²⁾

Parameter	Cumbal	Values			l lmi4	Note / Test Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge ¹⁾	Q _{gs}	-	13	18.8	nC	$V_{\rm DD}$ =7.5 V, $I_{\rm D}$ =30 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge at threshold ¹⁾	Q _{g(th)}	-	7.6	11	nC	V_{DD} =7.5 V, I_{D} =30 A, V_{GS} =0 to 4.5 V
Gate to drain charge ¹⁾	Q _{gd}	-	5.7	5.5	nC	V_{DD} =7.5 V, I_{D} =30 A, V_{GS} =0 to 4.5 V
Switching charge	Q _{sw}	-	11.1	-	nC	V_{DD} =7.5 V, I_{D} =30 A, V_{GS} =0 to 4.5 V
Gate charge total ¹⁾	Qg	-	29	36	nC	V_{DD} =7.5 V, I_{D} =30 A, V_{GS} =0 to 4.5 V
Gate plateau voltage	V _{plateau}	-	2.7	-	V	V_{DD} =7.5 V, I_{D} =30 A, V_{GS} =0 to 4.5 V
Gate charge total ¹⁾	Qg	-	44	55	nC	V_{DD} =7.5 V, I_{D} =30 A, V_{GS} =0 to 7 V
Output charge ¹⁾	Qoss	-	27	36	nC	V _{DS} =7.5 V, V _{GS} =0 V

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

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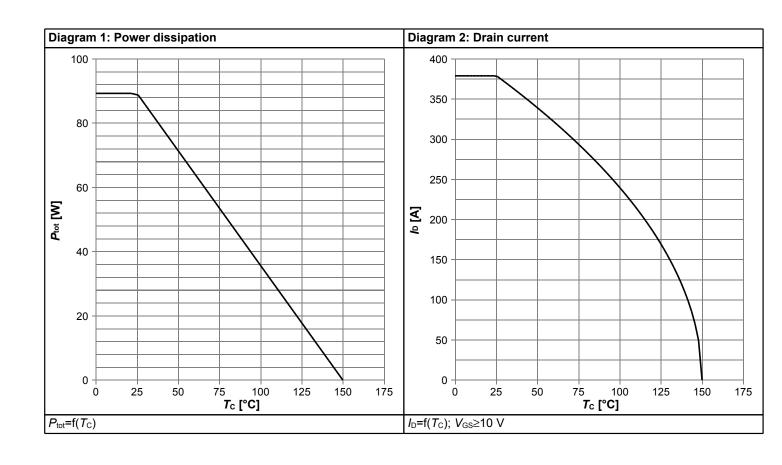


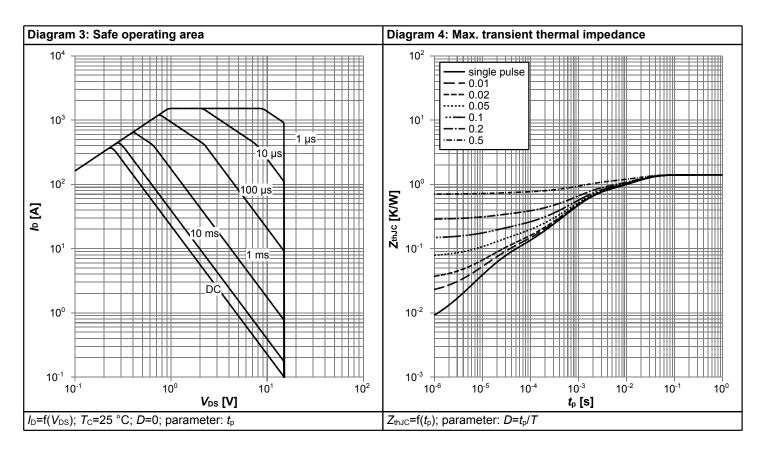
Table 7 Reverse diode

Parameter	Cumbal		Values			Nata / Tank Canadition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	87	Α	<i>T</i> _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	1516	Α	<i>T</i> _C =25 °C
Diode forward voltage	V _{SD}	-	0.76	1.0	V	V _{GS} =0 V, I _F =30 A, T _j =25 °C
Reverse recovery time ¹⁾	t _{rr}	-	31	62	ns	V_R =7.5 V, I_F =30 A, di_F/dt =100 A/ μ s
Reverse recovery charge ¹⁾	Qrr	-	24	48	nC	V _R =7.5 V, I _F =30 A, di _F /dt=100 A/μs
Reverse recovery time ¹⁾	t _{rr}	-	25	50	ns	V _R =7.5 V, I _F =30 A, di _F /dt=300 A/μs
Reverse recovery charge ¹⁾	Qrr	-	49	98	nC	V_R =7.5 V, I_F =30 A, di_F/dt =300 A/ μ s

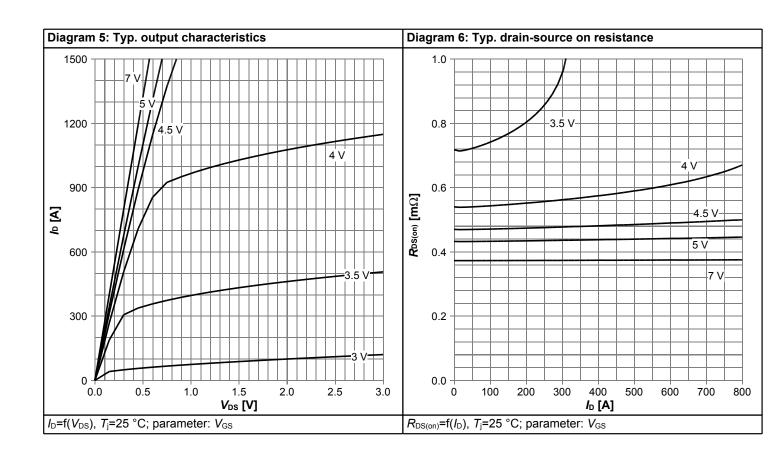


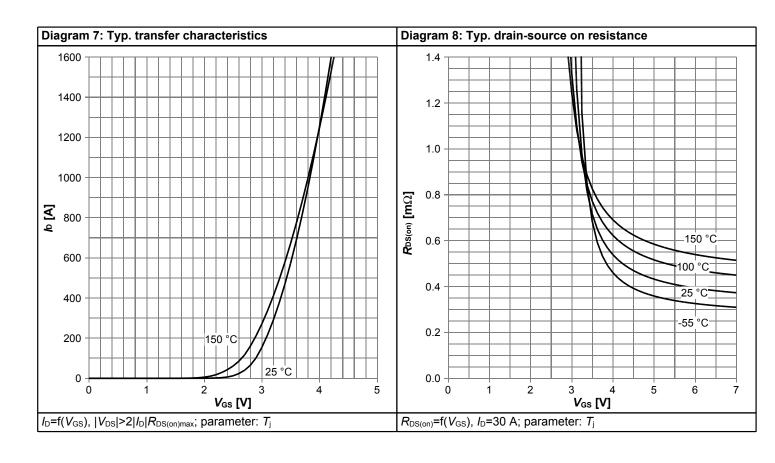
4 Electrical characteristics diagrams



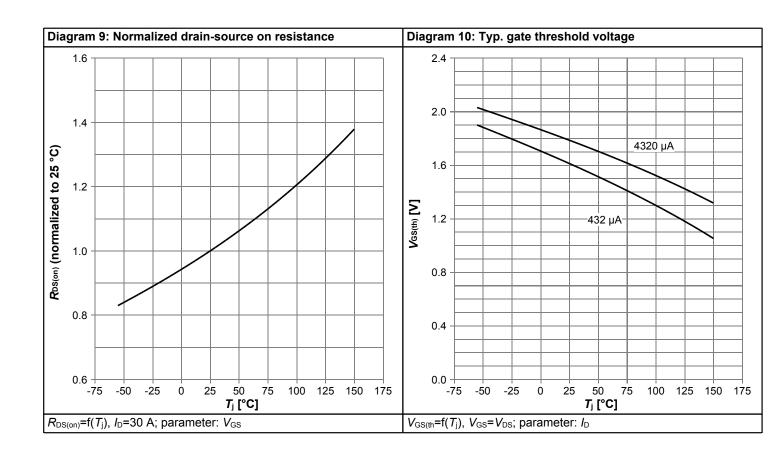


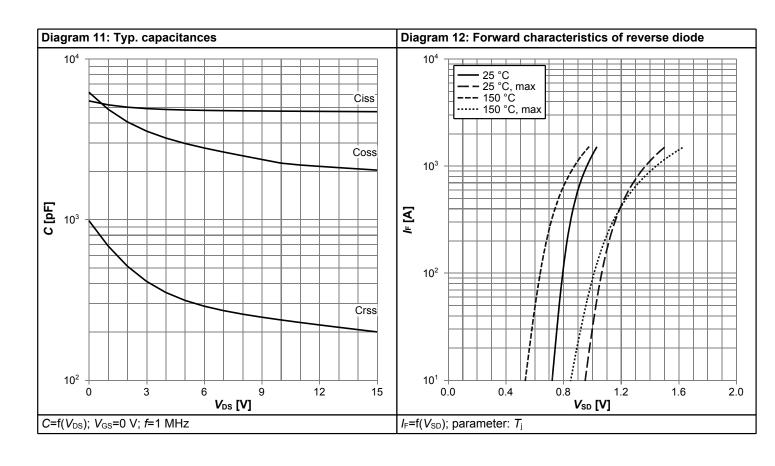




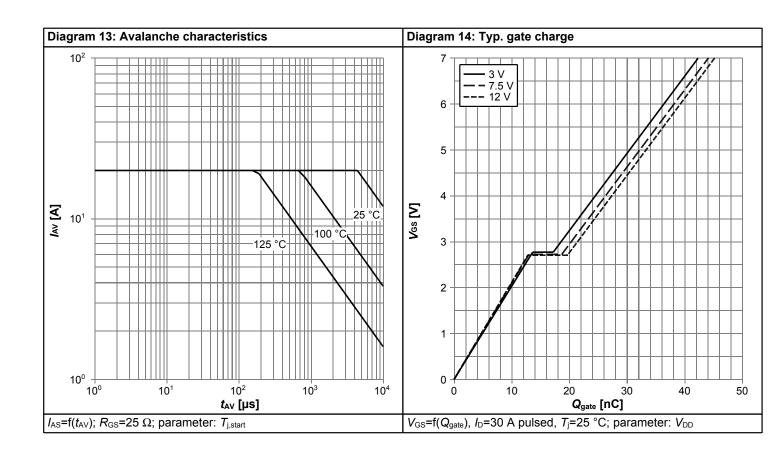


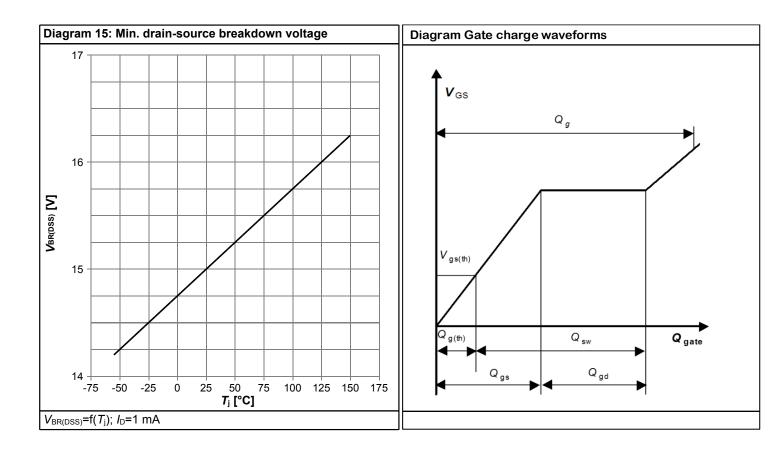














5 Package Outlines

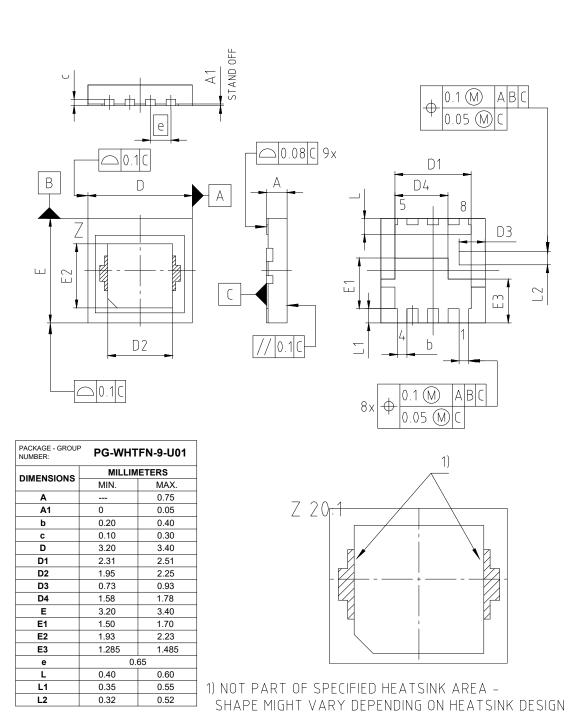


Figure 1 Outline PG-WHTFN-9, dimensions in mm

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Revision History

IQE004NE1LM7CGSC

Revision: 2023-07-25, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)			
2.0	2023-07-25	Release of final version			

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